

# MGV High Current Molded SMT Power Inductors MGV0302 Series

#### **FEATURES AND APPLICATIONS**

Laird MGV series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and molded construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

#### **FEATURES**

- Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and miniaturization
- · High reliability

#### **APPLICATIONS**

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



#### **PART NUMBER EXPLANATION**



**Note:** Automotive grade parts are also available, a specific P.N will be assigned upon request. Please contact laird local sales for details.

#### **ELECTRICAL SPECIFICATIONS**

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100KHz, 1.0V
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 60%(MAX.)

**Note:** Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air.

The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.

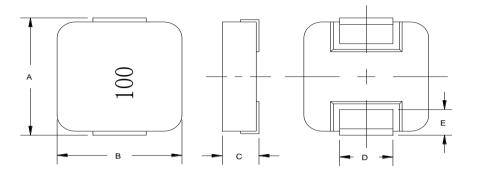


#### **Molded SMT Power Inductors**

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### SPECIFICATION FOR APPROVAL

#### 1.MECHANICAL & DIMENSIONS



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(UNIT: mm)
3.50±0.20
3.20±0.20
1.80±0.20
1.20±0.20
0.70±0.20
4.10 ref
1.90 ref
1.45 ref

**REMARK** 

#### 2.PART NUMBER NOMENCLATOR:

MGV 0302

100 M - 1X

Α

В

C

D E

A: Product Series.

B: Series number, part size

C: Inductance code

D: Inductance Tolerance. (M=±20%, N=±30%)

E: "X"=0:Standard catalog part number

"X"=1-9:Controlled customized part **Or** different performance than std catalog part. And "5-9" is for automotive grade.

#### 3.EQUIVALENT CIRCUIT:





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PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Typ	DCR(mΩ) Max	REMARK
MGV0302R10N-10	0.10±30%	10.5	14.0	6.6	9.0	
MGV0302R22N-10	0.22±30%	9.0	11.2	11.0	14.0	
MGV0302R47M-10	0.47±20%	7.0	9.0	19.7	23.0	
MGV0302R68M-10	0.68±20%	5.5	7.0	25.5	29.0	
MGV0302R82M-10	0.82±20%	4.8	6.0	27.0	32.0	
MGV03021R0M-10	1.00±20%	4.0	5.0	32.0	38.0	
MGV03021R2M-10	1.20±20%	3.9	4.5	39.0	47.0	
MGV03021R5M-10	1.50±20%	3.8	4.0	42.0	50.0	
MGV03022R2M-10	2.20±20%	3.5	3.7	65.0	75.0	
MGV03023R3M-10	3.30±20%	3.0	3.5	125	145	
MGV03024R7M-10	4.70±20%	2.6	3.0	172	200	
MGV03026R8M-10	6.80±20%	1.9	2.2	260	300	
MGV0302100M-10	10.0±20%	1.4	1.6	366	422	

- 1, Test conditions(L): 100KHz, 1Vrms
- 3, Storage temperature: -10°C to +40°C
- 4, Humidity range: 60% RH Max.
- 5, Heat Rated Current (Irms) will cause the coil temperature rise approximately ∆t of 40°C
- 6, Saturation Current (Isat) will cause L0 to drop approximately 30%.

o, Catalation Carron (ISA) will sadde to to drop approximately 6676.
7, Part Temperature (Ambient+Temp. Rise) : Should not exceed 125°C under worst case operating cond
8, Storage condition (component in its packaging)

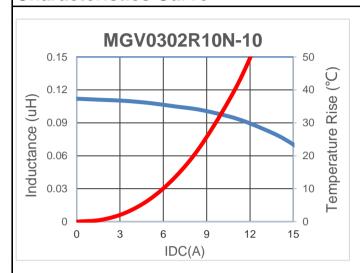


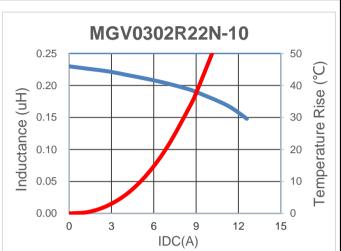
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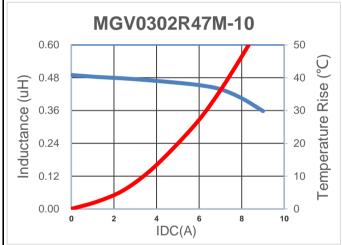
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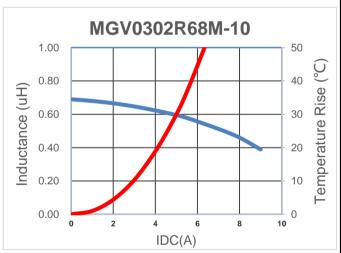
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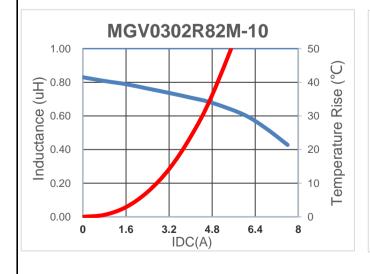
#### **Characteristics Curve**

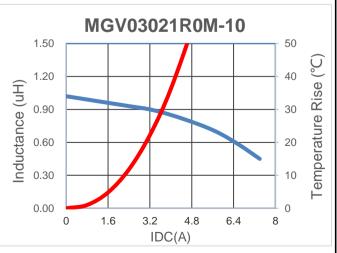












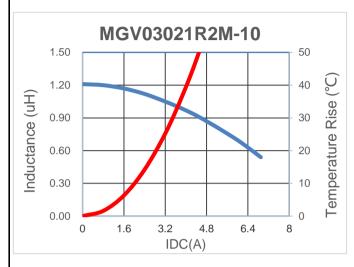


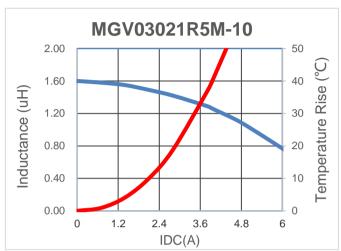
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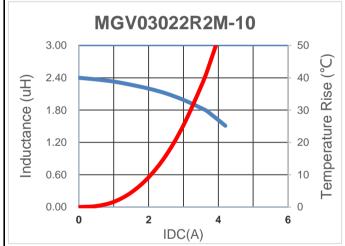
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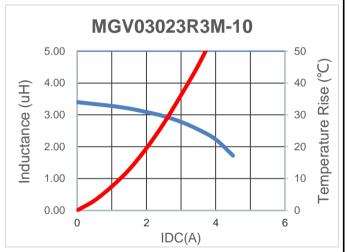
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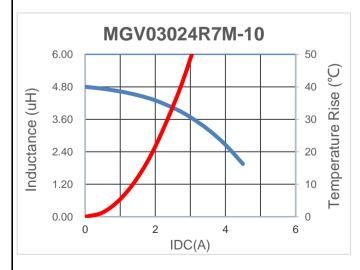
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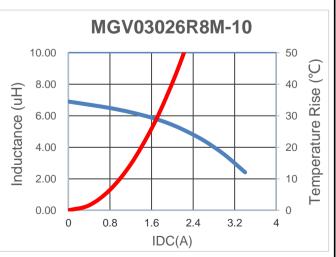












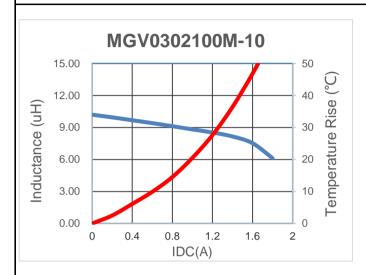


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### SPECIFICATION FOR APPROVAL

### **Characteristics Curve**





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Recommended Soldering Conditions

## For Lead-Free Application Figure 1 . Re-flow Soldering RECOMMENDED SOLDERING CONDITIONS preheating soldering cooling 255°C MAX:255°C TEMPERATURE 150°C 240°C 190°C -20~40sec. Gradual Cooling 90±30sec.**⊦** TIME(SEC.) Reflow times: 3 times max Figure 2. Hand Soldering PRE-HEATING SOLDERING NATURAL 280 230 150 Over 1 min. Gradual Cooling Within 3 sec.

Hand solder times: 1 time max



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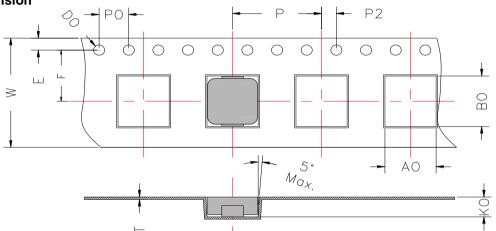
Reliabilitv and Testing Conditions / Pin Tvpe Power Inductors					
SMD series(Consumer)					
Item	Reference	Additional Requirements			
Operating temperature range	-55°C∼ +125°C (Including self-temperature rise)				
Storage temperature and humidity range	-10℃ to +40℃,60% RH Max				
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours			
Temperature Cycling	JESD22 Method JA-104	-40°C →+85, transforming interval:20s, 100cycles			
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing			
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrical Test not required.			
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required			
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)			
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5°C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu			
Solderability	J-STD-002	245±5℃, 5±1sec, Solder: Sn/3.0Ag/0.5Cu			
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures			
Board Flex	AEC-Q200-005	2mm,30±1s			
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct			



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#### **PACKAGING Reel Dimension** Type A(mm) B(mm) C(mm) D(mm) 13'x12 12.4+2/-0 $100 \pm 2$ 13+0.5/-0.2 330 **Tape Dimension**

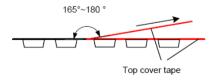


W	Е	F	Р	A0	B0	P2	P0	K0	t	D0
12.0±0.	3 1.75±0.1	5.5±0.1	8±0.1	3.5±0.1	3.8±0.1	2.0±0.1	4.0±0.1	2.3±0.1	0.35±0.05	1.5Ref.

#### **Packaging Quantity**

P/N Chip/Reel		Inner Box	Outer Box	
MGV0302 Series 3000pcs		6000pcs	12000pcs	
Size	Э	-	-	

#### **Peeling Off Force**



The force peeling off cove tape is 10 to 100 grams							
in the arrow direction under the following conditions							
Room Temp   Room   Room atrn   Teaming							
(℃)	(℃) Humidity (hPa) Speed						
5~35 45~85 860~1060 300							

- **%Storage Conditions** 1. Temperature and humidity conditions: -10-+40 $^{\circ}$ C
- 2. Recommended products should be used within 12 mont from the time of manufacturing.
- 3. The packaging material should be kept where no chlorin or sulfur exists in the air.
- 4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking

### **Mouser Electronics**

**Authorized Distributor** 

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### **Laird Performance Materials:**

<u>MGV0302R47M-10</u> <u>MGV0302100M-10</u> <u>MGV0302R68M-10</u> <u>MGV03023R3M-10</u> <u>MGV03026R8M-10</u> <u>MGV0302R82M-10</u> <u>MGV03022R2M-10</u> <u>MGV0302R10N-10</u> <u>MGV0302R22N-10</u> <u>MGV03021R2M-10</u> <u>MGV03021R5M-10</u> MGV03021R0M-10